



Spec No. :DS20-2020-0071 Effective Date: 02/27/2021

Revision: -

**LITE-ON DCC** 

RELEASE

BNS-OD-FC001/A4



# Through Hole Lamp

## LTL-R42FBYH106PT

<u>Rev</u>	<u>Description</u>	<u>By</u>	<u>Date</u>
P01	Preliminary Specification (RDR-20200234-01), Tape & Reel Packing	Javy H.	03/27/2020
	Above data for PD and Customer tracking	ng only	
-	New Specification. Upload on OPB2 System	Javy H.	10/27/2020



### 1. Description

CBI (Circuit Board Indicator) is a black plastic right angle Holder (Housing) which mates with Lite-On LED lamps. Lite-On CBI is available in a wide variety of packages, including top-view (Spacer) or right angle and horizontal or vertical arrays which is stackable and easy to assembly.

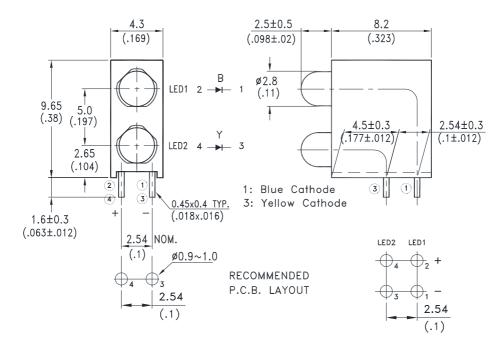
### 1. 1. Features

- Designed for ease in circuit board assembly
- Black case enhance contrast ratio
- Low power consumption & High efficiency
- Lead free product & RoHS Compliant
- T-1 lamp : Source color are InGaN blue 470nm and AllnGaP 587nm chips
- It is in tape and reel packing.

### 1.2. Applications

- Communication
- Computer
- Consumer
- Industrial

### 2. Outline Dimensions



### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm (.010") unless otherwise noted.
- 3. The Holder (Housing) material is plastic / black or dark gray.
- 4. LED1 is green Blue color & blue diffused lens; LED2 is yellow & yellow diffused lens.
- 5. Specifications are subject to change without notice.

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## 3. Absolute Maximum Ratings at TA=25℃

Parameter	Blue	Yellow	Unit	
Power Dissipation	117	78	mW	
Peak Forward Current				
(Duty Cycle≦1/10, Pulse Width≦10µs)	90	60	mA	
DC Forward Current	20	30	mA	
Operating Temperature Range	-30℃ to + 85℃			
Storage Temperature Range	-40℃ to + 100℃			
Lead Soldering Temperature				
[2.0mm (.079") From Body]	260℃ for 5 Seconds Max.			

## 4. Electrical / Optical Characteristics at TA=25℃

Parameter	Symbol	Color	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	Blue	180	400	880	mad	IF=20mA
Luminous Intensity	IV	Yellow	180	400	880	mcd	Note 1,4
Viouing Anglo	201/2	Blue		65		doa	Note 2 (Fig.6)
Viewing Angle	201/2	Yellow		65		deg	Note 2 (Fig.6)
Dook Emission Wayslangth	, D	Blue		468			Measurement
Peak Emission Wavelength	λP	Yellow		588		nm	@Peak (Fig.1)
Dansin and Marralan oth	λd	Blue	460	470	475		IF=20mA
Dominant Wavelength		Yellow	584	587	594	nm	Note 3
On a street Line Line Line ( N/: -th-	۸.	Blue		25			
Spectral Line Half-Width	Δλ	Yellow		15		nm	
Famous Maltana	\/_	Blue		3.2	3.8	3.8	IF 00 A
Forward Voltage	VF	Yellow		2.0	2.5	V	IF=20mA
D	10	Blue			10		\/D_5\/_N_1.
Reverse Current	IR	Yellow			10	μA	VR=5V, Note 5

### **NOTE:**

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- $2. \theta 1/2$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Iv guarantee must be included with ±15% testing tolerance.
- 5. Reverse voltage (VR) condition is applied for IR test only. The device is not designed for reverse operation.

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## 5. Typical Electrical / Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted) **LED1** (Blue)

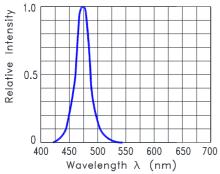
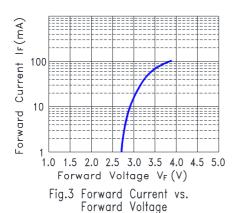
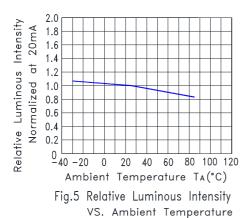


Fig.1 Relative Intensity VS. Wavelength





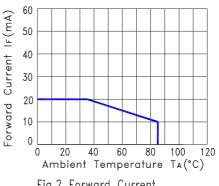


Fig.2 Forward Current Derating Curve

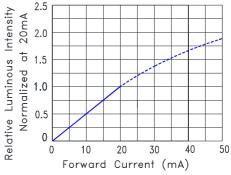


Fig.4 Relative Luminous Intensity vs. Forward Current

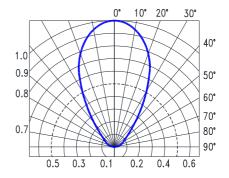


Fig.6 Spatial Distribution



### **LED2 (Yellow)**

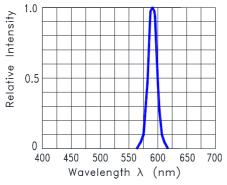
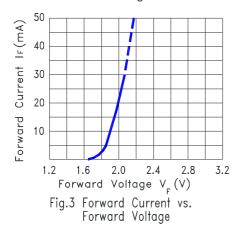


Fig.1 Relative Intensity VS. Wavelength



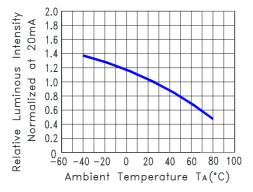


Fig.5 Relative Luminous Intensity vs. Ambient Temperature

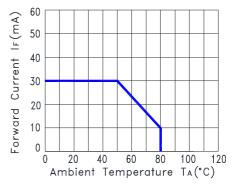


Fig.2 Forward Current Derating Curve

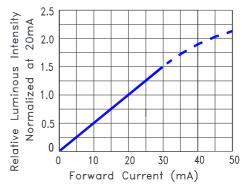


Fig.4 Relative Luminous Intensity vs. Forward Current

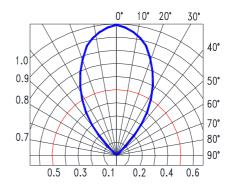
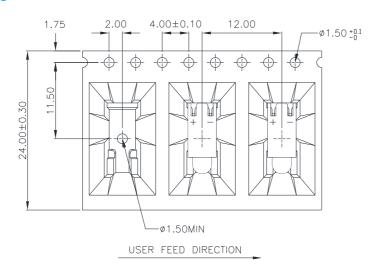


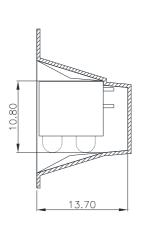
Fig.6 Spatial Distribution



## 6. Packing Specification

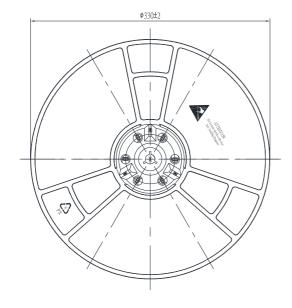
### **Packing Carrier Dimensions**

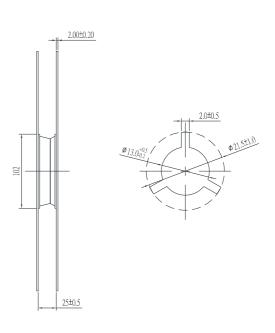




- 1. 10 sprocket hole pitch cumulative tolerance ±0.20
- 2. Material: Black Conductive Polystyrene Alloy
- 3. Thickness: 0.50 ±0.06 mm
- 4. Component load per 13" reel: 350pcs

### **Packing Reel Dimensions**







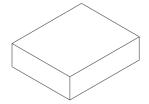


### **Carton Specification**

2 Reels with 1 Humidity indicator card and 2 Desiccants are packed in 1 Moisture Barrier Bag (MBB)

1 Moisture Barrier Bag packed in 1 Inner Carton

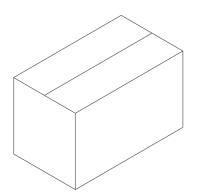
Total 700pcs (350pcs\*2) per Inner Carton



INNER CARTON 361 x 358 x 75 mm

10 Inner Cartons per Outer Carton

Total 7,000pcs (700pcs\*10) per Outer Carton



OUTER CARTON 740 x 390 x 395 mm



## 7. Bin Table Specification for Reference

### **Blue color**

Luminous Intensity, Unit: mcd, IF=20mA					
Iv Bin Code	Min.	Max.			
Н	180	240			
J	240	310			
К	310	400			
L	400	520			
М	520	680			
N	680	880			

Note: Tolerance of each bin limit is ±15%

Dominant Wavelength, Unit :nm, IF=20mA					
Hue Bin Code	Min.	Max.			
B07	460.0	465.0			
B08	465.0	470.0			
B09	470.0	475.0			

Note: Tolerance of each bin limit is ±1nm



### **Yellow color**

Lumino	ous Intensity Unit : mcd	@20mA
Bin Code	Min.	Max.
HJ	180	310
KL	310	520
MN	520	880

Note: Tolerance of each bin limit is ±15%

Dominant Wavelength Unit : nm @20mA					
Bin Code	Min	Max			
H15	584.0	586.0			
H16	586.0	588.0			
H17	588.0	590.0			
H18	590.0	592.0			
H19	592.0	594.0			

Note: Tolerance of each bin limit is ±1nm



# Through Hole Lamp

### 8. CAUTIONS

### 8.1. Application

This LED lamp is good for application of indoor and outdoor sign, also ordinary electronic equipment.

### 8.2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is re commended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

### 8.3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

### 8.4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming. Lead forming must be done before soldering, at normal temperature. During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

### 8.5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens/Holder to the soldering point. Dipping the lens/Holder into the solder must be avoided. Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

### **Recommended soldering conditions:**

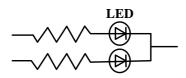
	Soldering iron	1	Wave soldering		
Temperature Soldering time	350℃ Max. 3 seconds Max. (one time only)	Pre-heat Pre-heat time Solder wave	120℃ Max. 100 seconds Max. 260℃ Max.		
Position	No closer than 2mm from the base of the epoxy bulb	Soldering time Dipping Position	5 seconds Max.  No lower than 2mm from the base of the epoxy bulb		

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED.

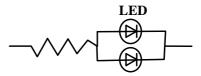
### 8.6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

### Circuit model (A)



### Circuit model (B)



- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

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### 8.7. ESD (Electrostatic Discharge)

### Static Electricity or power surge will damage the LED.

### Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

### Suggested checking list:

### **Training and Certification**

- 8.7.1.1. Everyone working in a static-safe area is ESD-certified?
- 8.7.1.2. Training records kept and re-certification dates monitored?

### **Static-Safe Workstation & Work Areas**

- 8.7.2.1. Static-safe workstation or work-areas have ESD signs?
- 8.7.2.2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 8.7.2.3. All ionizer activated, positioned towards the units?
- 8.7.2.4. Each work surface mats grounding is good?

### **Personnel Grounding**

- 8.7.3.1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 8.7.3.1. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 8.7.3.2. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V\*?
- 8.7.3.3. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 8.7.3.4. All wrist strap or heel strap checkers calibration up to date? Note: \*50V for Blue LED.

### **Device Handling**

- 8.7.4.1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 8.7.4.2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 8.7.4.3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 8.7.4.4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

#### **Others**

- 8.7.5.1. Audit result reported to entity ESD control coordinator?
- 8.7.5.2. Corrective action from previous audits completed?
- 8.7.5.3. Are audit records complete and on file?

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## 9. Reliability Test

Classification	Test Item	Test Condition	Sample Size	Reference Standard
	Operation Life	Ta = Under room temperature IF = per datasheet maximum drive current Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1026 (1995) MIL-STD-883G:1005 (2006)
Endurance	High Temperature High Humidity storage	Ta = 60℃ RH = 90% Test Time= 240hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-202G:103B (2002) JEITA ED-4701:100 103 (2001)
Test	High Temperature Storage	Ta= 105 ± 5℃ Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1031 (1995) MIL-STD-883G:1008 (2006) JEITA ED-4701:200 201 (2001)
	Low Temperature Storage	Ta= -55 ± 5℃ Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	JEITA ED-4701:200 202 (2001)
	Temperature Cycling	$100^{\circ}$ C $\sim 25^{\circ}$ C $\sim -40^{\circ}$ C $\sim 25^{\circ}$ C 30mins 5mins 30mins 5mins 30 Cycles	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1051 (1995) MIL-STD-883G:1010 (2006) JEITA ED-4701:100 105 (2001) JESD22-A104C (2005)
	Thermal Shock	100 ± 5℃ ~ -30℃ ± 5℃ 15mins 15mins 30 Cycles (<20 secs transfer)	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1056 (1995) MIL-STD-883G:1011 (2006) MIL-STD-202G:107G (2002) JESD22-A106B (2004)
Environmental Test	Solder Resistance	T.sol = $260 \pm 5$ °C Dwell Time= $10\pm 1$ seconds 3mm from the base of the epoxy bulb	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2031(1995) JEITA ED-4701: 300 302 (2001)
	Solderability	T. sol = $245 \pm 5$ °C Dwell Time= $5 \pm 0.5$ seconds (Lead Free Solder, Coverage $\geq 95$ % of the dipped surface)	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2026 (1995) MIL-STD-883G:2003 (2006) MIL-STD-202G:208H (2002) IPC/EIA J-STD-002 (2004)
	Soldering Iron	T. sol = $350 \pm 5\%$ Dwell Time= $3.5 \pm 0.5$ seconds	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-202G:208H (2002) JEITA ED-4701:300 302 (2001)

### 10. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.